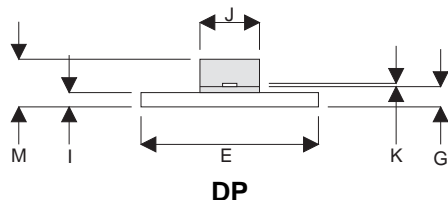
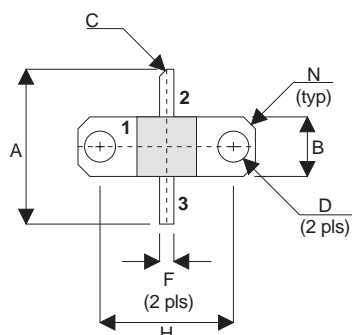


MECHANICAL DATA



PIN 1 SOURCE PIN 2 DRAIN
PIN 3 GATE

| DIM | mm | Tol. | Inches | Tol. |
|-----|------------|------|-------------|-------|
| A | 16.51 | 0.25 | 0.650 | 0.010 |
| B | 6.35 | 0.13 | 0.250 | 0.005 |
| C | 45° | 5° | 45° | 5° |
| D | 3.30 | 0.13 | 0.130 | 0.005 |
| E | 18.92 | 0.08 | 0.745 | 0.003 |
| F | 1.52 | 0.13 | 0.060 | 0.005 |
| G | 2.16 | 0.13 | 0.085 | 0.005 |
| H | 14.22 | 0.08 | 0.560 | 0.003 |
| I | 1.52 | 0.13 | 0.060 | 0.005 |
| J | 6.35 | 0.13 | 0.250 | 0.005 |
| K | 0.13 | 0.03 | 0.005 | 0.001 |
| M | 5.08 | 0.51 | 0.200 | 0.020 |
| N | 1.27 x 45° | 0.13 | 0.050 x 45° | 0.005 |

GOLD METALLISED MULTI-PURPOSE SILICON DMOS RF FET 10W – 12.5V – 1GHz SINGLE ENDED

FEATURES

- SIMPLIFIED AMPLIFIER DESIGN
- SUITABLE FOR BROAD BAND APPLICATIONS
- LOW C_{rss}
- SIMPLE BIAS CIRCUITS
- LOW NOISE
- HIGH GAIN – 10 dB MINIMUM

APPLICATIONS

- VHF/UHF COMMUNICATIONS
from DC to 1 GHz

ABSOLUTE MAXIMUM RATINGS ($T_{case} = 25^{\circ}C$ unless otherwise stated)

| | | |
|--------------|--|-------------------------|
| P_D | Power Dissipation | 42W |
| BV_{DSS} | Drain – Source Breakdown Voltage | 40V |
| BV_{GSS} | Gate – Source Breakdown Voltage | $\pm 20V$ |
| $I_{D(sat)}$ | Drain Current | 8A |
| T_{stg} | Storage Temperature | -65 to $150^{\circ}C$ |
| T_j | Maximum Operating Junction Temperature | $200^{\circ}C$ |

Semelab Plc reserves the right to change test conditions, parameter limits and package dimensions without notice. Information furnished by Semelab is believed to be both accurate and reliable at the time of going to press. However Semelab assumes no responsibility for any errors or omissions discovered in its use. Semelab encourages customers to verify that datasheets are current before placing orders.

ELECTRICAL CHARACTERISTICS (T_{case} = 25°C unless otherwise stated)

| Parameter | Test Conditions | Min. | Typ. | Max. | Unit |
|--|---|------|------|------|------|
| BV _{DSS} Drain–Source Breakdown Voltage | V _{GS} = 0 I _D = 10mA | 40 | | | V |
| I _{DSS} Zero Gate Voltage Drain Current | V _{DS} = 12.5V V _{GS} = 0 | | | 1 | mA |
| I _{GSS} Gate Leakage Current | V _{GS} = 20V V _{DS} = 0 | | | 1 | μA |
| V _{GS(th)} Gate Threshold Voltage* | I _D = 10mA V _{DS} = V _{GS} | 0.5 | | 7 | V |
| g _{fs} Forward Transconductance* | V _{DS} = 10V I _D = 0.8A | 0.72 | | | S |
| G _{PS} Common Source Power Gain | P _O = 10W | 10 | | | dB |
| η Drain Efficiency | V _{DS} = 12.5V I _{DQ} = 0.4A | 40 | | | % |
| VSWR Load Mismatch Tolerance | f = 1GHz | 20:1 | | | — |
| C _{iss} Input Capacitance | V _{DS} = 0 V _{GS} = –5V f = 1MHz | | | 48 | pF |
| C _{oss} Output Capacitance | V _{DS} = 12.5V V _{GS} = 0 f = 1MHz | | | 40 | pF |
| C _{rss} Reverse Transfer Capacitance | V _{DS} = 12.5V V _{GS} = 0 f = 1MHz | | | 4 | pF |

* Pulse Test: Pulse Duration = 300 μs , Duty Cycle ≤ 2%

HAZARDOUS MATERIAL WARNING

The ceramic portion of the device between leads and metal flange is beryllium oxide. Beryllium oxide dust is highly toxic and care must be taken during handling and mounting to avoid damage to this area.

THESE DEVICES MUST NEVER BE THROWN AWAY WITH GENERAL INDUSTRIAL OR DOMESTIC WASTE.

THERMAL DATA

| | | |
|-----------------------|------------------------------------|----------------|
| R _{THj-case} | Thermal Resistance Junction – Case | Max. 4.2°C / W |
|-----------------------|------------------------------------|----------------|

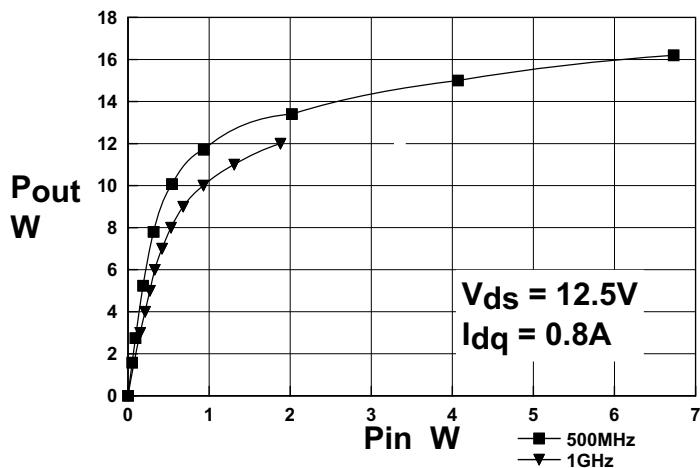


Figure 1- Power Output vs. Power Input

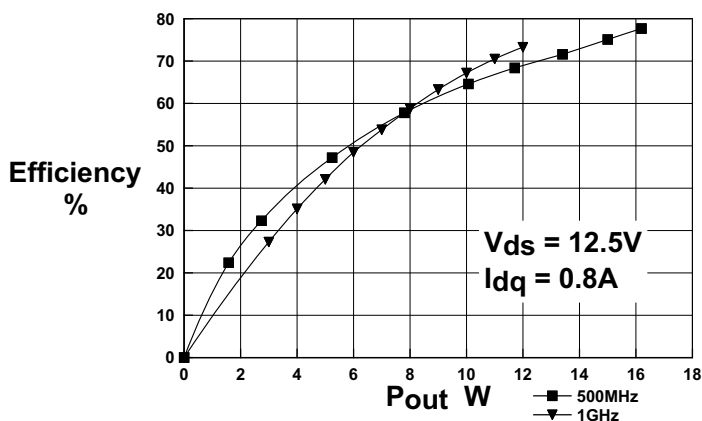


Figure 2 - Efficiency vs Output Power

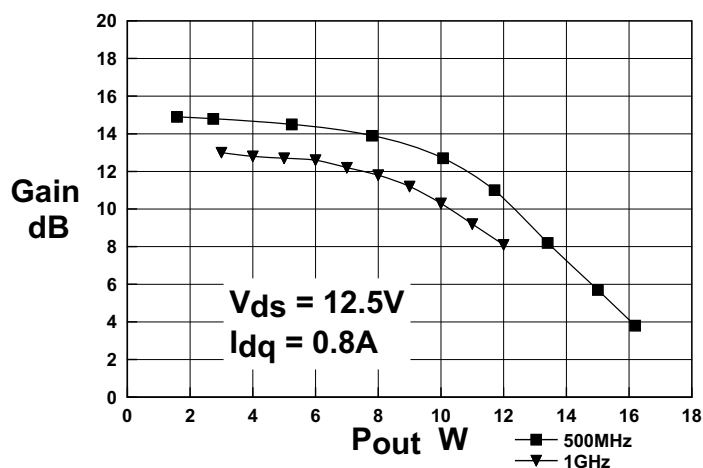


Figure 3 - Gain vs Power Output

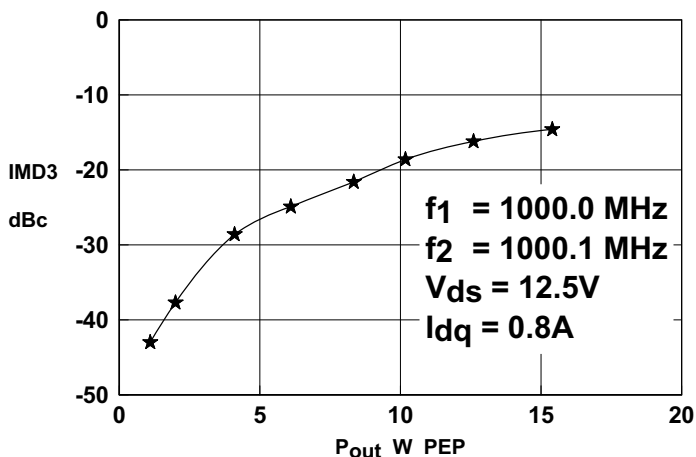


Figure 4 - IMD vs Output Power

D2212UK OPTIMUM SOURCE AND LOAD IMPEDANCE

| Frequency MHz | Z_S Ω | Z_L Ω |
|------------------|-------------------|-------------------|
| 1000MHz | $0.9 - j4.9$ | $1.9 - j7.3$ |

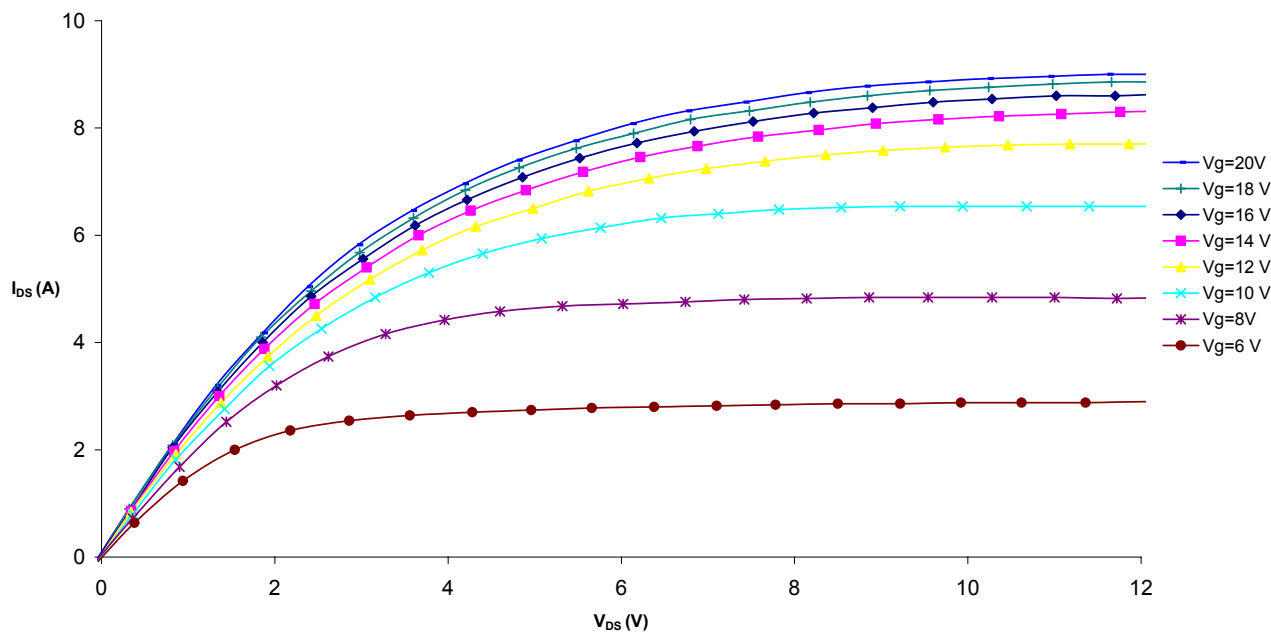


Figure 5 – Typical IV Characteristics.

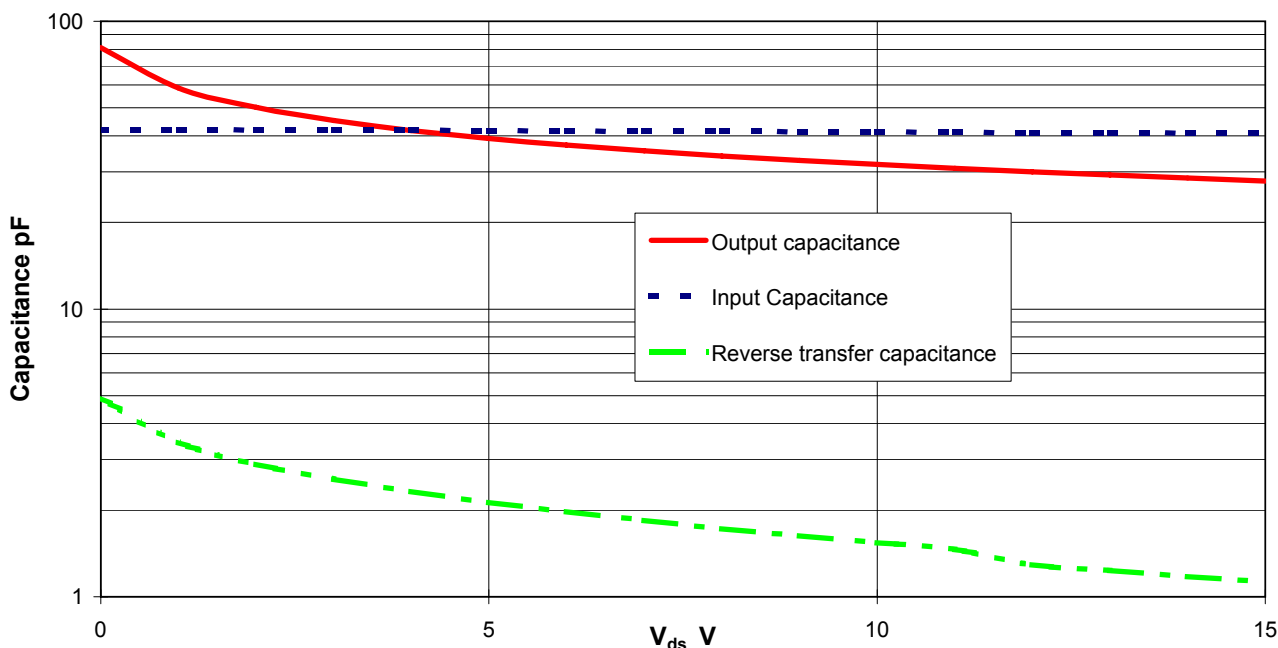
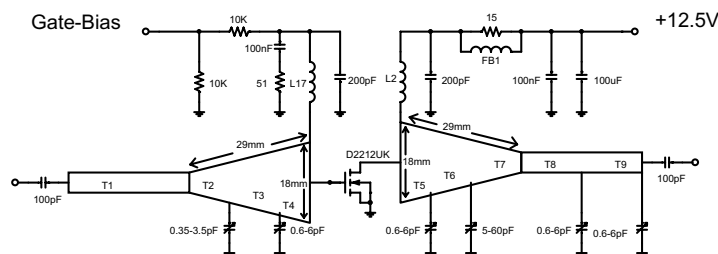


Figure 6 – Typical CV Characteristics.



Substrate 0.8mm PTFE/glass

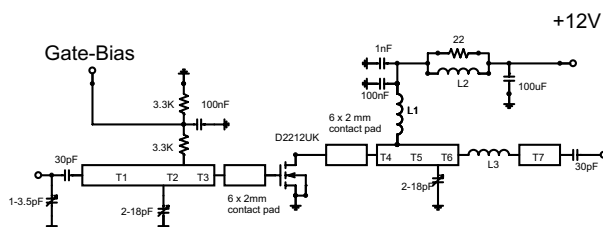
| | |
|-----------------|-----------------|
| T1 28mm 50 Ohms | T6 14mm |
| T2 11mm | T7 10mm |
| T3 11mm | T8 11mm 50 Ohms |
| T4 7mm | T9 17mm 50 Ohms |

T5 5mm

FB1 Murata BL02RN1-R62

L1,L2 10 turns 22swg enamelled copper wire, 6mm i.d.

Figure 7 - 1GHz Test Fixture



Substrate 0.8mm PTFE/glass, Er=2.5

All microstrip lines W=2.2mm

T1 32mm

T2 4mm

T3 5mm

T4 3mm

T5 9mm

T6 7.5mm

T7 13mm

L1 6 turns 0.5mm dia enamelled copper wire, 3mm i.d.

L2 1.5 turns 0.5mm enamelled copper wire on Siemens B62152A7 2 hole ferrite core

L3 1/16" dia wire hairpin loop 15mm long

Figure 8 - 500MHz Test Fixture

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